

# **Product Change Notification - JAON-02XYUD377**

Date:

05 Sep 2019

**Product Category:** 

**Ethernet Switches** 

**Affected CPNs:** 



#### **Notification subject:**

CCB 3599.002 Final Notice: Qualification of ASE as a new assembly site for selected Micrel KSZ8895 device family available in 128L PQFP (14x20x2.72mm) package.

#### **Notification text:**

**PCN Status:** 

Final notification

**PCN Type:** 

Manufacturing Change

## **Microchip Parts Affected:**

Please open one of the icons found in the Affected CPNs section above.

**NOTE:** For your convenience Microchip includes identical files in two formats (.pdf and .xls)

## **Description of Change:**

Qualification of ASE as a new assembly site for selected Micrel KSZ8895 device family available in 128L PQFP (14x20x2.72mm) package

#### **Pre Change:**

Assembled at OSE using silver (Ag) bonding wire and G700L mold compound

## **Post Change:**

Assembled at ASE using gold (Au) bonding wire and EME-G631H mold compound

**Pre and Post Change Summary:** 

	Pre Change	Post Change			
Assembly Site	Orient Semiconductor Electronics, Ltd (OSE)	ASE Inc. (ASE)			
Wire material	Ag	Au			
Die attach material	CRM-1076WA	CRM-1076WA			
Molding compound material	G700L	EME-G631H			
Lead frame material	C7025	C7025			

# Impacts to Data Sheet:

None

# **Change Impact:**

None

## **Reason for Change:**

To improve productivity and on-time delivery performance by qualifying ASE as a new additional assembly site.

## **Change Implementation Status:**

In Progress

# **Estimated First Ship Date:**

October 3, 2019 (date code: 1940)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts



## **Time Table Summary:**

	September 2019				October 2019				
Workweek	36	37	38	39	40	41	42	43	44
Qual Report Availability	X								
Final PCN Issue Date	X								
Estimated Implementation					V				
Date					^				

# Method to Identify Change:

Traceability code

## **Qualification Report:**

Please open the attachments included with this PCN labeled as PCN\_#\_Qual Report.

# **Revision History:**

**September 5, 2019:** Issued final notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

#### Attachment(s):

PCN\_JAON-02XYUD377\_Qual\_Report.pdf

Please contact your local <u>Microchip sales office</u> with questions or concerns regarding this notification.

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If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

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## Affected Catalog Part Numbers (CPN)

KSZ8895FQXC

KSZ8895FQXCA

KSZ8895FQXC-TR

KSZ8895FQXI

KSZ8895FQXIA

KSZ8895FQXI-TR

KSZ8895MQXC

KSZ8895MQXCA

KSZ8895MQXC-TR

KSZ8895MQXI

KSZ8895MQXIA

KSZ8895MQXI-TR

KSZ8895RQXC

KSZ8895RQXCA

KSZ8895RQXCA-TR

KSZ8895RQXC-TR

KSZ8895RQXI

KSZ8895RQXIA

KSZ8895RQXI-TR

Date: Thursday, September 05, 2019